

PDN Number:	20170609002	PDN Date:	June 12, 2017
Title:	Discontinuance of select devices produced in STATS ChipPAC (SCS)		
Customer Contact:	PCN Manager	Dept:	Quality Services
Last date to order:	June 12, 2018	Last date to ship:	Dec 12, 2018
Change Type:	Product Discontinuance - End Of Life		
Product Discontinuance Notification Details			
Description of Discontinuance:			
Texas Instruments, Incorporated (TI) is announcing the discontinuance of select devices produced in STATS ChipPAC (SCS). A life time buy is being offered per the date shown above. Recommended replacements are also offered on some devices as shown in the Product Affected Section.			
NOTE: There are no samples offered for withdrawn/obsolete products. For samples of any replacement products, please contact your local sales representative.			
Reason for Withdrawal/Discontinuance:			
SCS is discontinuing the solder paste printing process			
Product Affected:			
DEVICES BEING DISCONTINUED	RECOMMENED REPLACEMENT PRODUCTS	REPLACEMENT CODES	
SN74AUP1G125YZTR	SN74AUP1G125YZPR	S	
TXS0206-29YFPR	TXS0206-29YFPRB	S	
Replacement Notes:			
F = Similar functionality but not equivalent.			
P = Same functionality but not pin-for-pin equivalent and may not be parametrically equivalent.			
Q = Same functionality and PIN-OUT as the compared device but is NOT an exact equivalent.			
S = EXACT equivalent in functionality and parametrically to the compared device.			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com